



**MAINTENANCE MANUAL
FOR
GE-NET TMX™
AUDIO BOARD 19D902047G1**

LBI-38113

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DESCRIPTION

Audio Board 19D902047G1 used with the GE-NET TMX™ 900 MHz trunked radio provides all Audio, Data, and Tone processing for the radio except for Volume Control and Audio Power Amplifier. The Audio Board interfaces with the logic board, and receives logic signals from the microcontroller for RX, Data/ Voice, and TX Data muting. The audio board also contains the receiver squelch circuit with the internal squelch control. A Block Diagram of the audio board is shown in Figure 1.

The audio board is mounted in the top front of the radio housing assembly, and connects to the logic board through an 18 pin connector, J703.

The audio board contains the following primary circuits:

- transmit audio and data
- receive audio and data

Both the transmit and receive audio and data signals include tones. A general description of the primary circuit functions follows.

CIRCUIT ANALYSIS

TRANSMIT AUDIO CIRCUITS

Transmit audio includes voice (microphone path), signal tones, and 4800 Baud data (MTX). Audio for the transmit circuit is preemphasized, limited, and coupled through a post limiter (low pass) filter.

Transmit signal tones that are generated on the logic board are filtered to remove any voice band harmonics. When the

push-to-talk (PTT) is activated, transmit audio and signal tones are summed, and then coupled through a modem filter to the modulator (TX MOD). MTX data is also summed and filtered in the same circuit before modulation. A Block Diagram of the transmit audio circuits is shown in Figure 2.

TX Preemphasis, Filter and Limiting Amplifier

Audio from the microphone (MIC HI) is applied to the audio board at J703-8. The 560-ohm resistor sets the input impedance. Input to the active filter is DC-coupled through C301. The +8 Volts developed across R301 provides for microphone signal reception.

Operational amplifier U301B and associated circuitry operates as an active 6dB/octave preemphasis filter (preemphasis from 300 to 3000 Hz), and limiting amplifier. The output of U301B is applied to a post limiter filter circuit.

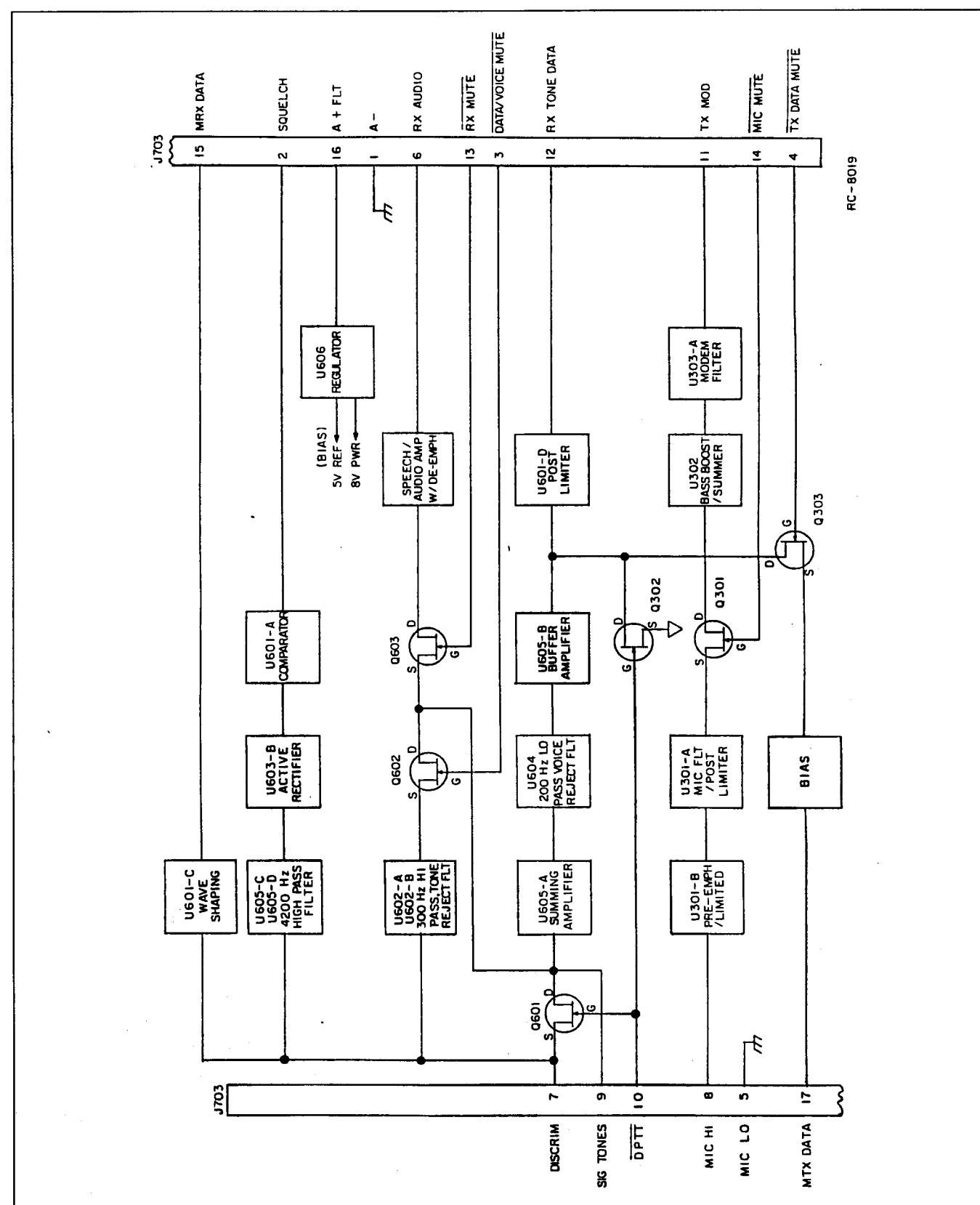
Clamping diodes D301A and D301B with the voltage divider R302 through R302J, bias the U301B inverting Op Amp at 4 volts, and limit the output to a nominal 3.6 volts peak-to-peak. Controlled limiting is provided by use of regulated power supplies for this circuit.

Post Limiter Filter

The Post Limiter Filter (PLF) following U301B consists of two sets of High/Low Pass filters. Between the RC filters is a third order, multiple feedback low pass filter (U301A). A Chebyshev low pass filter was chosen to minimize passband ripple (0.5dB) and provide sharp roll off at the high end of the voice band. Roll off for the Post Limiter and Summing amplifier is 28.3 dB / Octave.

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LBI-38113



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Figure 1 - Audio Board Block Diagram

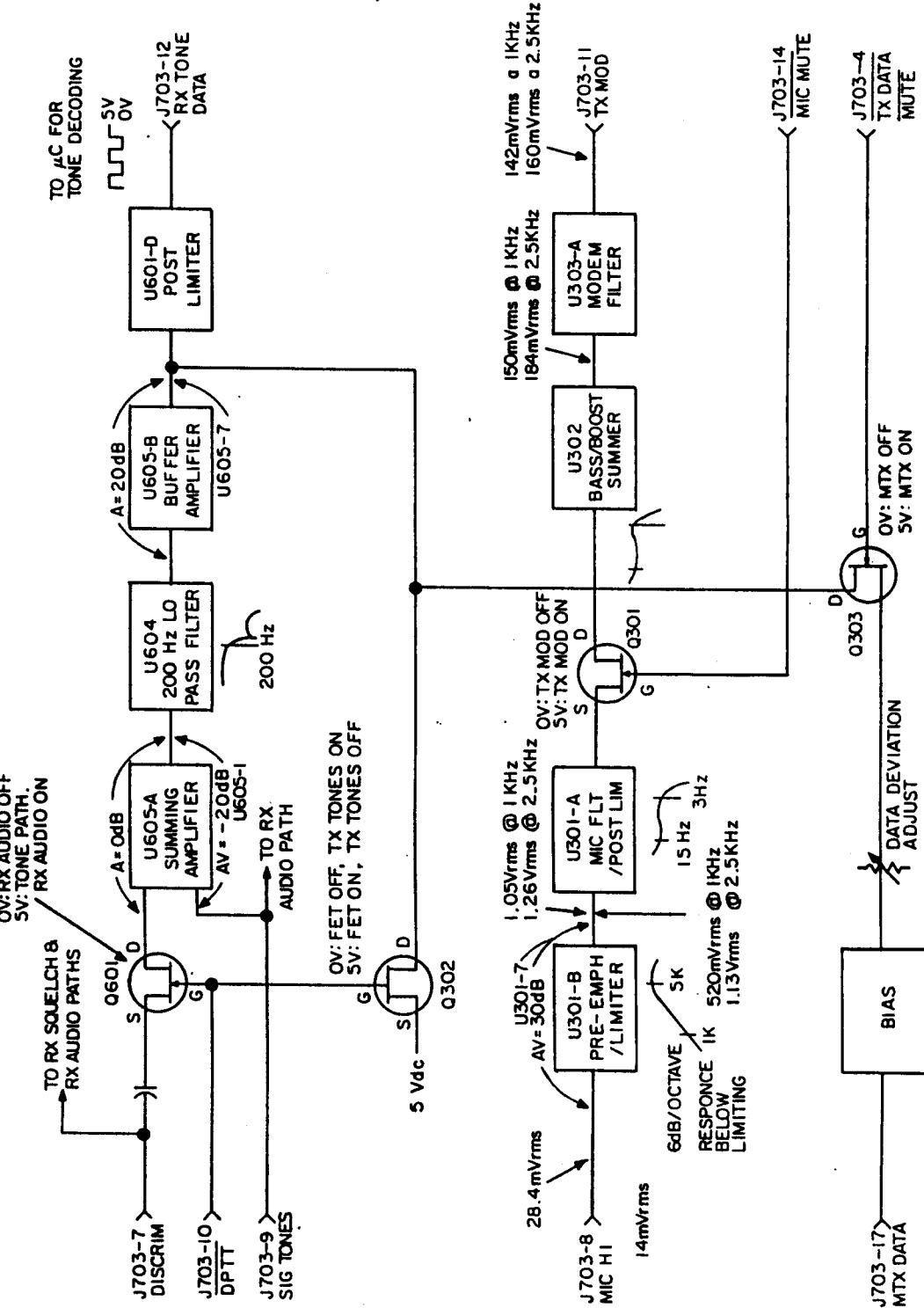


Figure 2- Transmit Audio Circuits

Summing Amplifier

The Post Limiter Filter sums the voice input into the low frequency compensation (Bass Boost) amplifier, U302A, along with subaudible tones and MTX data. Subaudible tones are audio signals generated on the Logic Board, applied to the Signal Tone input, and passed through the 200 Hz Low Pass Filter to remove the unwanted harmonic energy in the voice band. U302A sums the TX signals while amplifying those frequencies below 10 Hz. The gain is required to provide low frequency compensation for synthesizer modulation.

Compensation Amplifier

When the DPTT line is low, (in the transmit state), the filtered tones are summed into compensation amp then coupled through the Modem Filter to "TX MOD". A constant set level for these tones is assured with the use of a regulated power supply for the microcontroller and latch on the Logic Board.

MTX Data from the Logic Board's Modem IC is normally in a high impedance state except when enabled to send data at standard logic levels. To maintain a symmetrical swing about the quiescent bias level, the unloaded input is biased at approximately 2.3 Vdc. Potentiometer R324 adjusts the Data Deviation level. After the MTX Data is biased, it is summed into the Bass Boost Amplifier.

FET Gates

Field Effect Transistor (FET) gates operate as P-channel switches. FET Q301 operates as a gate for switching the TX Audio signal on or off, and is controlled by the Mic Mute signal from the microcontroller. When turned off, FET transistor Q302 (controlled by the DPTT line) allows Signal Tones to be summed. MTX Data is summed when Q303 is activated by the TX DATA MUTE input.

Modem Filter

Modem Filter U303A and associated circuitry consists of two second order, low pass (Butterworth) filters with unity gain. The circuit provides flat passband response, and provides additional transmit path high end roll off (12 dB/Octave). From the post limiter filter to the Modem Filter output at J703-11, roll off at 3000 Hz is 36dB/Octave. The 20 kHz attenuation for the radio is 84.3 dB minimum, with a 1K reference. Nominal passband gain is 0.222 V/V.

RECEIVE AUDIO CIRCUITS

Receive audio consists of audio, signal tones, 4800 Baud data (MRX), and squelch detector (CAS). The receive audio is coupled through a 300 Hz, high-pass tone reject filter, and then applied to an audio amplifier with the required deemphasis. Subaudible data is coupled through a 200 Hz low pass, voice reject filter and limiter.

MRX data is AC-coupled to a 3400 Hz low pass filter (data limiter), and then to an inverting comparator with hysteresis. The receiver squelch path consists of a 4.2 kHz high pass filter, a noise rectifier/amplifier and a comparator.

A Block Diagram of the receiver audio circuits is shown in Figure 3.

300 Hz High Pass Filter and Audio Amp

The Discriminator input signal at J703-7 contains both receive audio (voice) and data. The voice path consists of two, third order, 300 Hz high pass (Subaudible Reject) filters. The first is a Butterworth filter (U602A) to provide low ripple in the passband. The second, a Chebyshev (U602B) is for greater attenuation of the low frequencies. The two filters provide 18 dB/Octave of low frequency attenuation and unity gain.

S Data/Voice Mute controls FET transistor Q602 to provide audio mute. RX Mute allows both voice audio and controller-generated Signal tones to be summed at Speech Audio Amplifier U603A. Capacitor C617 provides 6 dB/Octave speech deemphasis for the circuit. The RX Audio output at J703-6 is biased at 5 volts.

200 Hz Low Pass Filter and Tone Limiter

Subaudible RX Signals at J703-9 are summed at U605A when the DPTT is low (FET Q601 enabled). This path is also used by TX Signals. The gate also allows for bypassing the filter for decoding transmitting signals greater than 200 Hz. The signal from the summer is passed to the 200 Hz Low Pass (Voice Reject) Filter. U604A and U604B make up Frequency Dependent Negative Resistance 1 (FDNR), of the filter. The FDNR mimics an LC ladder circuit. FDNR 1 is used to provide for a sharp roll off at high (voice) frequencies. U604C and U604D of FDNR 2, allow for smoothing of the passband, and continued attenuation of frequencies above 200 Hz.

The output of the filter is passed through buffer amplifier U605B to Data Limiter U601D. The Limiter

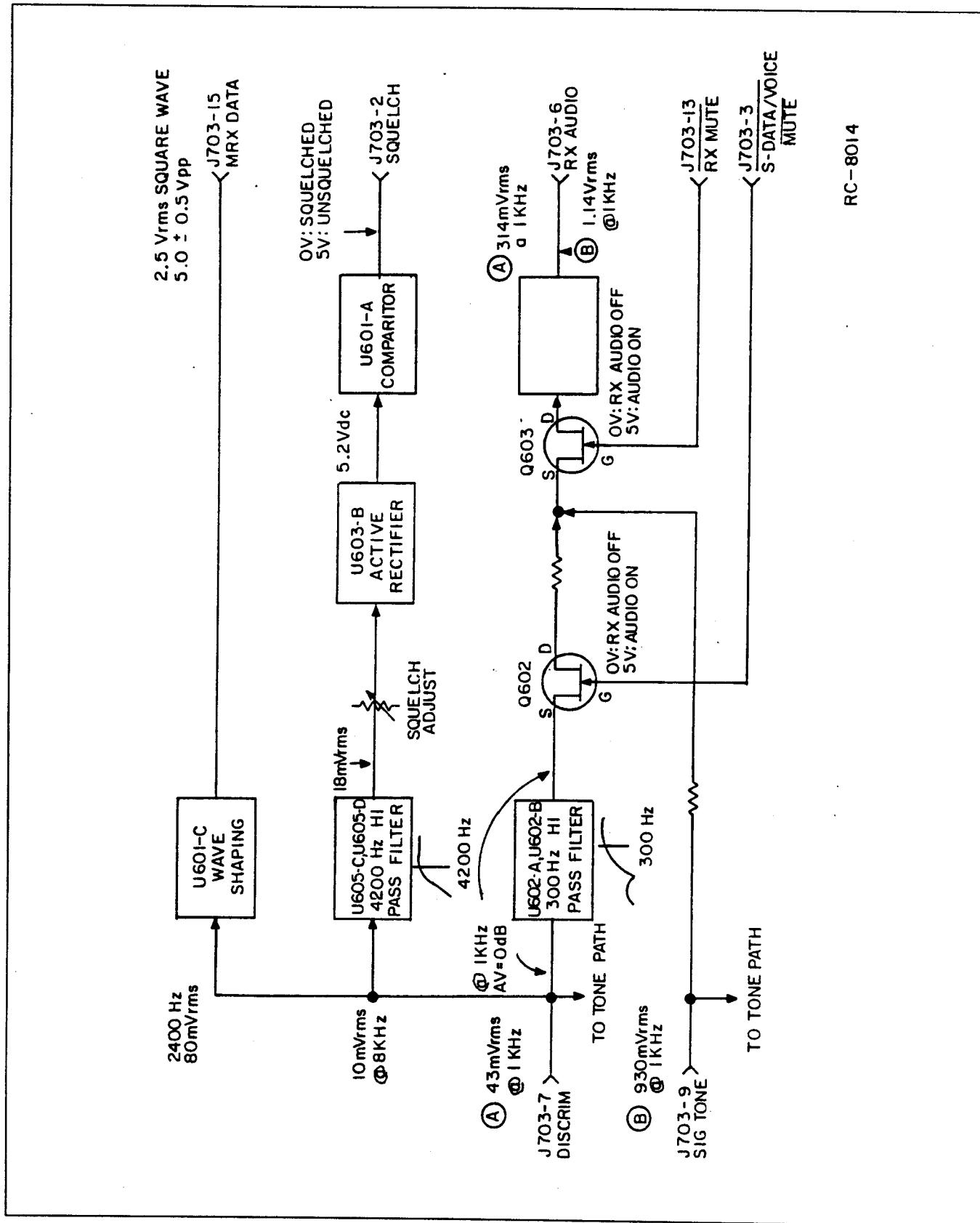


Figure 3 - Receive Audio Circuits

provides wave shaping (5 volt p-p) for the RX Tone Data output at J703-12.

3400 Hz Data Limiter

MRX data in the Discriminator Audio is AC coupled to an RC type, 3400 Hz Low Pass filter consisting of R636 and C625. Inverting Comparator U601C provides hysteresis at a nominal 20 dB level below the data signal magnitude.

4200 Hz High Pass Filter

The discriminator output is also applied to a 4200 Hz, fifth order, multiple feedback high pass filter consisting of U605C, U605D and associated circuitry. The filter rejects all RX Tone, Voice, and Data signals.

Rectifier/Amplifier and Comparator

The noise output of the 4200 Hz highpass Chebyshev filter is applied to Rectifier/Amplifier U603B for comparison to the + 5 Volt reference at the Squelch Comparator (U601A).

A channel exhibits more noise when no signal is being received. When the receiver is squelched, the comparator CAS output (squelch) at J703-2 is low. Hysteresis is

provided to prevent the squelch circuit from chattering. Receive sensitivity (signal to noise/distortion) is set nominally to an 8 dB sinad level with R628.

QUICK CHECKS

1. Refer to the Block Diagrams (Figures 2 and 3) for proper signal levels and gains for the various audio paths.
2. Note the state of the FET switches for muting. These switches are controlled by the Logic Board. If a mute line is high (+ 5Volts), ground that pin and monitor the results. However if a mute line is low, the line may not be pulled high unless first disconnected from the Logic Board.
3. All bias points (+5 Volts) shown on the Audio Board Schematic Diagram are generated by Op Amp U303B. The other Op-Amp circuits will not operate properly without this voltage.
4. When measuring signal levels, remember that inverting (-) inputs, with feedback, are "virtual grounds". No AC voltages should be present at these ports.

PARTS LIST

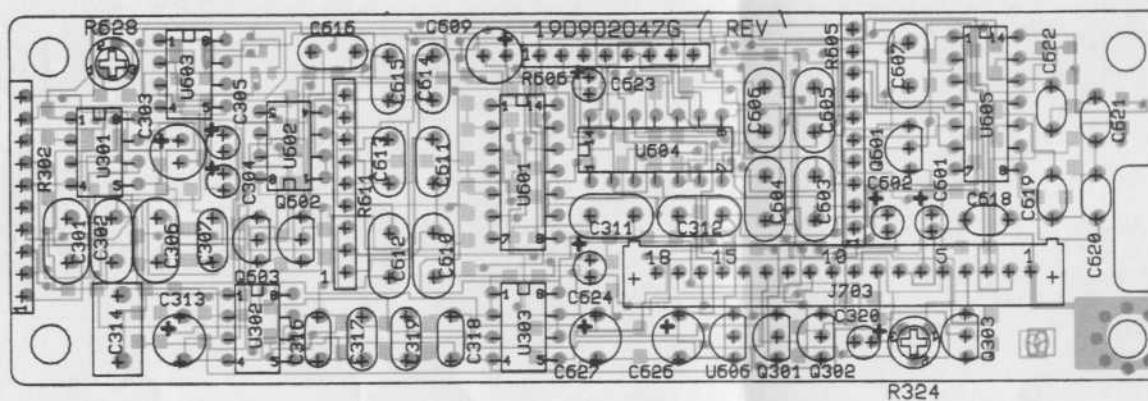
AUDIO BOARD
19D902047G1
ISSUE 2

SYMBOL	GE PART NO.	DESCRIPTION
----- CAPACITORS -----		
C301	T644ACP410J	Polyester: 0.1 uF + or - 5%, 50 VDCW.
C302	T644ACP347J	Polyester: .047 uF + or - 5%, 50 VDCW.
C303	19A704879P2	Electrolytic: 47 uF + or - 20%, 16 VDCW.
C304 and C305	19A704879P5	Electrolytic: 10 uF + or - 20%, 16 VDCW.
C306	T644ACP410J	Polyester: 0.1 uF + or - 5%, 50 VDCW.
C307	T644ACP315J	Polyester: .015 uF + or - 5%, 50 VDCW.
C308 thru C310	19A702061P89	Ceramic: 1500 pF + or - 5%, 50 VDCW, temp coef 0 + or - 30 PPM.
C311	T644ACP415J	Polyester: .15 uF + or - 5%, 50 VDCW.
C312	T644ACP347J	Polyester: .047 uF + or - 5%, 50 VDCW.
C313	19A701534P7	Tantalum: 10 uF + or - 20%, 16 VDCW.
C314	19A70004P4	Metallized polyester: 0.22 uF + or - 10%, 63 VDCW.
C315	19A702052P3	Ceramic: 470 pF + or - 10%, 50 VDCW.
C316	T644ACP310J	Polyester: .010 uF + or - 5%, 50 VDCW.
C317	T644ACP322J	Polyester: .022 uF + or - 5%, 50 VDCW.
C318	T644ACP222J	Polyester: .0022 uF + or - 5%, 50 VDCW.
C319	T644ACP322J	Polyester: .022 uF + or - 5%, 50 VDCW.
C320	19A704879P4	Electrolytic: 22 uF + or - 20%, 50 VDCW.
C601 and C602	19A704879P8	Capacitor, Electrolytic: 2.2uF + or - 20%, 50 VDCW.
C603 thru C607	T644ACP368J	Polyester: .068 uF + or - 5%, 50 VDCW.
C608	19A702052P20	Ceramic: 0.033 uF + or - 10%, 50 VDCW.
C609	19A704879P2	Electrolytic: 47 uF + or - 20%, 16 VDCW.
C610	T644ACP368J	Polyester: .068 uF + or - 5%, 50 VDCW.
C611	T644ACP333J	Polyester: .033 uF + or - 5%, 50 VDCW.
C612	T644ACP368J	Polyester: .068 uF + or - 5%, 50 VDCW.
C613 thru C616	T644ACP333J	Polyester: .033 uF + or - 5%, 50 VDCW.
C617	19A702061P93	Ceramic: 2200 pF + or - 5%, 50 VDCW, temp coef 0 + or - 30 PPM.
C618 thru C622	T644ACP210J	Polyester: .0010 uF + or - 5%, 50 VDCW.
C623	19A704879P9	Electrolytic: 1 uF + or - 20%, 50 VDCW.
C624	19A704879P8	Capacitor, Electrolytic: 2.2uF + or - 20%, 50 VDCW.
C625	19A702052P14	Ceramic: 0.01 uF + or - 10%, 50 VDCW.
C626 and C627	19A701534P7	Tantalum: 10 uF + or - 20%, 16 VDCW.
----- DIODES -----		
D301	19A700053P2	Silicon, fast recovery (2 diodes in series).
D601	19A700053P2	Silicon, fast recovery (2 diodes in series).
----- JACKS -----		
J703	19A704874P1	Connector: sim to: Elco 00-9021-18-12-00-339.

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

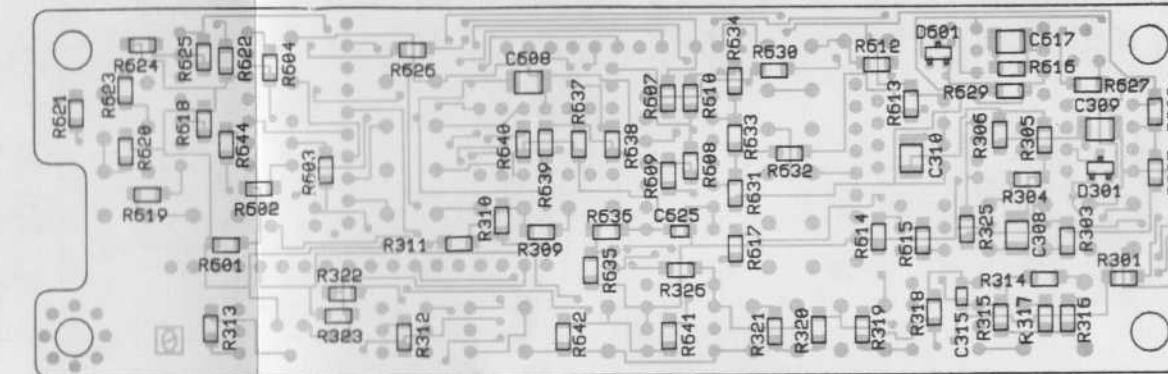
SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
Q301 thru Q303	19A134137P7	- - - - - TRANSISTORS - - - - - N-type, field effect.	R619	19A702931P289	Metal film: 8250 ohms + or - 1%, 200 VDCW, 1/8 w.
Q601 thru Q603	19A134137P7	N-type, field effect.	R620	19A702931P281	Metal film: 6810 ohms + or - 1%, 200 VDCW, 1/8 w.
R301	19B800607P561	- - - - - RESISTORS - - - - - Metal film: 560 ohms + or - 5%, 200 VDCW, 1/8 w.	R621	19A702931P385	Metal film: 75K ohms + or - 1%, 200 VDCW, 1/8 w.
R302	19A704885P6	Resistor Network, Custom: 10 Pins, .125 W.	R622	19A702931P374	Metal film: 57.6K ohms + or - 1%, 200 VDCW, 1/8 w.
R303	19B800607P682	Metal film: 6.8K ohms + or - 5%, 200 VDCW, 1/8 w.	R623	19A702931P341	Metal film: 26.1K ohms + or - 1%, 200 VDCW, 1/8 w.
R304	19A702931P381	Metal film: 68.1K ohms + or - 1%, 200 VDCW, 1/8 w.	R624 and R625	19A702931P301	Metal film: 10K ohms + or - 1%, 200 VDCW, 1/8 w.
R305	19A702931P401	Metal film: 100K ohms + or - 1%, 200 VDCW, 1/8 w.	R626	19B800607P562	Metal film: 5.6K ohms + or - 5%, 200 VDCW, 1/8 w.
R306 thru R308	19A702931P301	Metal film: 10K ohms + or - 1%, 200 VDCW, 1/8 w.	R627	19B800607P223	Metal film: 22K ohms + or - 5%, 200 VDCW, 1/8 w.
R309	19B800607P272	Metal film: 2.7K ohms + or - 5%, 200 VDCW, 1/8 w.	R628	19B800779P16	Variable, 100K ohms, + or - 25%, 100 VDCW, 3 watt.
R310	19B800607P102	Metal film: 1K ohms + or - 5%, 200 VDCW, 1/8 w.	R629	19B800607P332	Metal film: 3.3K ohms + or - 5%, 200 VDCW, 1/8 w.
R311	19B800607P473	Metal film: 47K ohms + or - 5%, 200 VDCW, 1/8 w.	R630	19B800607P223	Metal film: 22K ohms + or - 5%, 200 VDCW, 1/8 w.
R312	19B800607P474	Metal film: 470K ohms + or - 5%, 200 VDCW, 1/8 w.	R631	19A702931P212	Metal film: 13K ohms + or - 1%, 200 VDCW, 1/8 w.
R313	19B800607P473	Metal film: 47K ohms + or - 5%, 200 VDCW, 1/8 w.	R632	19B800607P332	Metal film: 3.3K ohms + or - 5%, 200 VDCW, 1/8 w.
R314	19B800607P333	Metal film: 33K ohms + or - 5%, 200 VDCW, 1/8 w.	R633	19B800607P104	Metal film: 100K ohms + or - 5%, 200 VDCW, 1/8 w.
R315 and R316	19B800607P274	Metal film: 270K ohms + or - 5%, 200 VDCW, 1/8 w.	R634	19B800607P332	Metal film: 3.3K ohms + or - 5%, 200 VDCW, 1/8 w.
R317	19B800607P103	Metal film: 10K ohms + or - 5%, 200 VDCW, 1/8 w.	R635	19B800607P103	Metal film: 10K ohms + or - 5%, 200 VDCW, 1/8 w.
R318	19A702931P269	Metal film: 5110 ohms + or - 1%, 200 VDCW, 1/8 w.	R636	19B800607P472	Metal film: 4.7K ohms + or - 5%, 200 VDCW, 1/8 w.
R319	19A702931P201	Metal film: 1000 ohms + or - 1%, 200 VDCW, 1/8 w.	R637	19B800607P153	Metal film: 15K ohms + or - 5%, 200 VDCW, 1/8 w.
R320	19A702931P322	Metal film: 16.5K ohms + or - 1%, 200 VDCW, 1/8 w.	R638	19B800607P105	Metal film: 1M ohms + or - 5%, 200 VDCW, 1/8 w.
R321	19A702931P210	Metal film: 1240 ohms + or - 1%, 200 VDCW, 1/8 w.	R639	19B800607P125	Metal film: 1.2M ohms + or - 5%, 200 VDCW, 1/8 w.
R322	19B800607P124	Metal film: 120K ohms + or - 5%, 200 VDCW, 1/8 w.	R640	19B800607P103	Metal film: 10K ohms + or - 5%, 200 VDCW, 1/8 w.
R323	19B800607P104	Metal film: 100K ohms + or - 5%, 200 VDCW, 1/8 w.	R641	19B800607P562	Metal film: 5.6K ohms + or - 5%, 200 VDCW, 1/8 w.
R324	19B800779P16	Variable, 100K ohms, + or - 25%, 100 VDCW, 3 watt.	R642	19B800607P103	Metal film: 10K ohms + or - 5%, 200 VDCW, 1/8 w.
R325	19A702931P269	Metal film: 5110 ohms + or - 1%, 200 VDCW, 1/8 w.	R644	19B800607P104	Metal film: 100K ohms + or - 5%, 200 VDCW, 1/8 w.
R326	19B800607P471	Metal film: 470K ohms + or - 5%, 200 VDCW, 1/8 w.	----- INTEGRATED CIRCUITS -----		
R601	19B800607P104	Metal film: 100K ohms + or - 5%, 200 VDCW, 1/8 w.	U301 thru U303	19A700086P4	Operation Amplifier, Dual OP AMP; sim to 4558 Type.
R602	19B800607P683	Metal film: 68K ohms + or - 5%, 200 VDCW, 1/8 w.	U601	19A134764P1	Linear: (VOLTAGE COMPARATOR).
R603	19B800607P224	Metal film: 220K ohms + or - 5%, 200 VDCW, 1/8 w.	U602 and U603	19A700086P4	Operation Amplifier, Dual OP AMP; sim to 4558 Type.
R604	19B800607P683	Metal film: 68K ohms + or - 5%, 200 VDCW, 1/8 w.	U604 and U605	19A701789P1	Linear, Low Power OP AMP; sim to LM324N.
R605	19A704885P9	Resistor Network, Custom: 10 pins, .125 W.	U606	19A704673P2	Voltage Regulator, positive.
R606	19A704885P10	Resistor Network, Custom: 8 pins, .125 W.			
R607	19B800607P103	Metal film: 10K ohms + or - 5%, 200 VDCW, 1/8 w.			
R608	19B800607P105	Metal film: 1M ohms + or - 5%, 200 VDCW, 1/8 w.			
R609	19B800607P125	Metal film: 1.2M ohms + or - 5%, 200 VDCW, 1/8 w.			
R610	19B800607P103	Metal film: 10K ohms + or - 5%, 200 VDCW, 1/8 w.			
R611	19A704885P8	Resistor Network, Custom: 9 pins, .125 W.			
R612	19A702931P289	Metal film: 6250 ohms + or - 1%, 200 VDCW, 1/8 w.			
R613	19A702931P333	Metal film: 21.5K ohms + or - 1%, 200 VDCW, 1/8 w.			
R614	19B800607P103	Metal film: 10K ohms + or - 5%, 200 VDCW, 1/8 w.			
R615	19B800607P622	Metal film: 8.2K ohms + or - 5%, 200 VDCW, 1/8 w.			
R616	19B800607P224	Metal film: 220K ohms + or - 5%, 200 VDCW, 1/8 w.			
R617	19B800607P563	Metal film: 56K ohms + or - 5%, 200 VDCW, 1/8 w.			
R618	19A702931P409	Metal film: 121K ohms + or - 1%, 200 VDCW, 1/8 w.			

COMPONENT SIDE



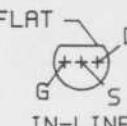
(19D902047, Rev. 0)
(19D902046, Sh. 1, Rev. 0)
(19D902046, Sh. 2, Rev. 0)

SOLDER SIDE



(19D902047, Rev. 0)
(19D902046, Sh. 2, Rev.)

**LEAD IDENTIFICATION
FOR Q301-Q303 & Q601-Q603**

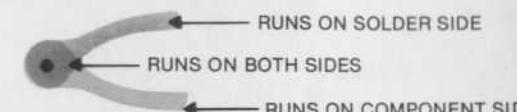


NOTE: CASE SHAPE IS DETERMINING
FACTOR FOR LEAD IDENTIFICATION

**LEAD IDENTIFICATION
FOR D301 & D601**

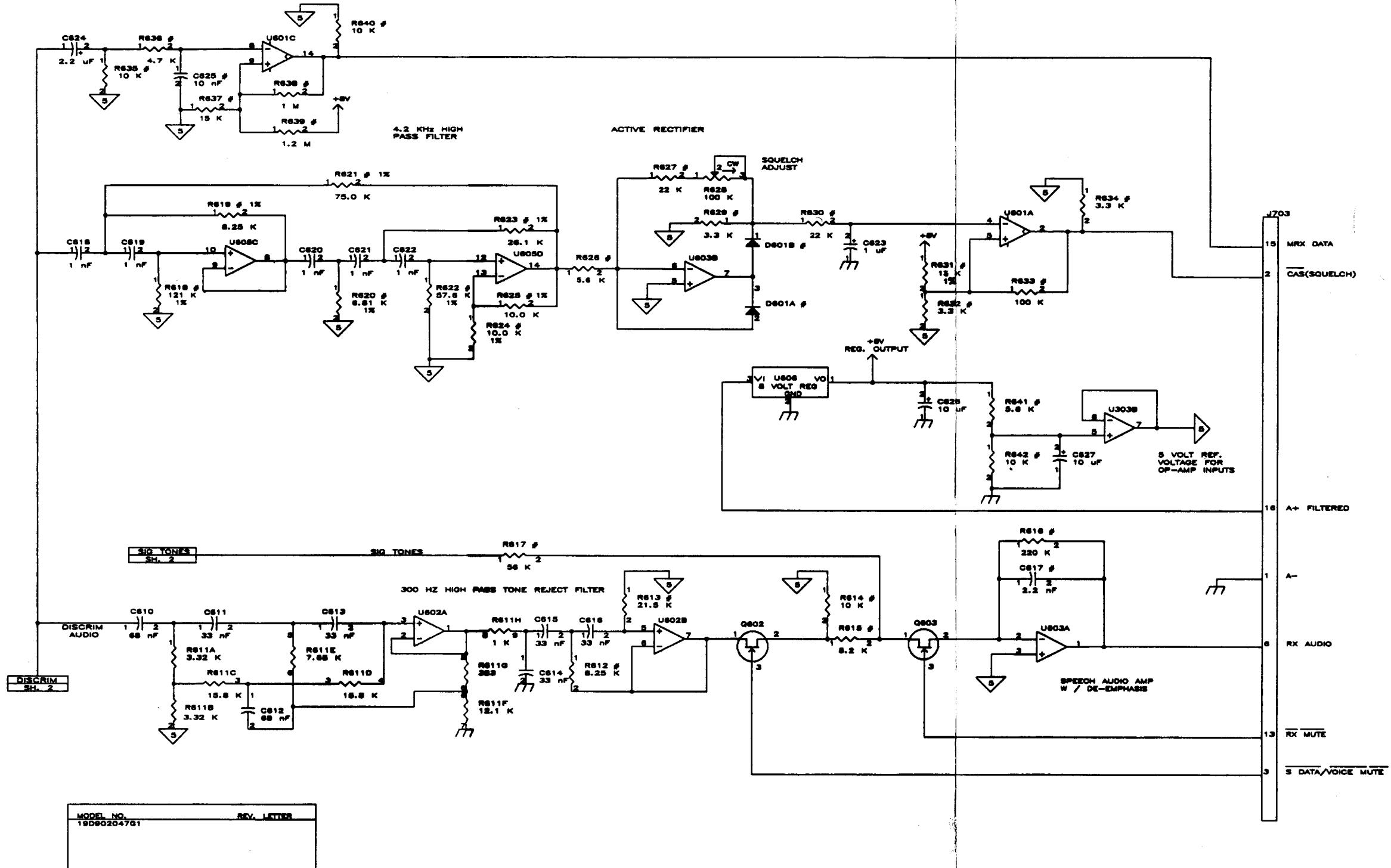


VIEW FROM SOLDER SIDE



SCHEMATIC DIAGRAM

LBI-38113



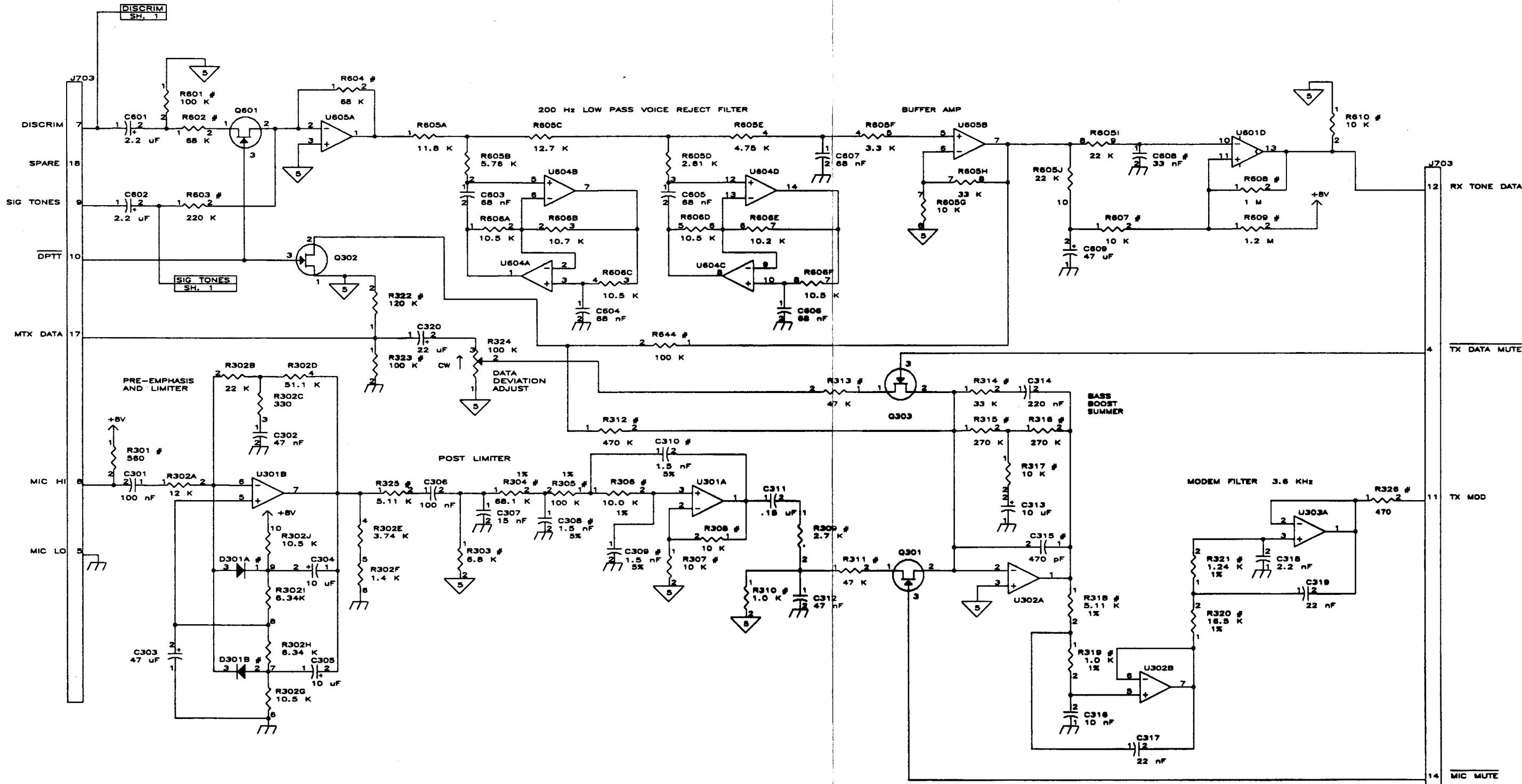
NOTES

1. ALL RESISTORS ARE 1/8 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K = 1000 OHMS OR M = 1,000,000 OHMS. CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY μ = MICROFARADS. INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH = MILLIHENRYS OR H = HENRYS.

(19D902194, Sh. 1, Rev. 1)

2. # INDICATES CHIP COMPONENT LOCATED ON SOLDER SIDE OF PCB

GE-NET TMX
Audio Board

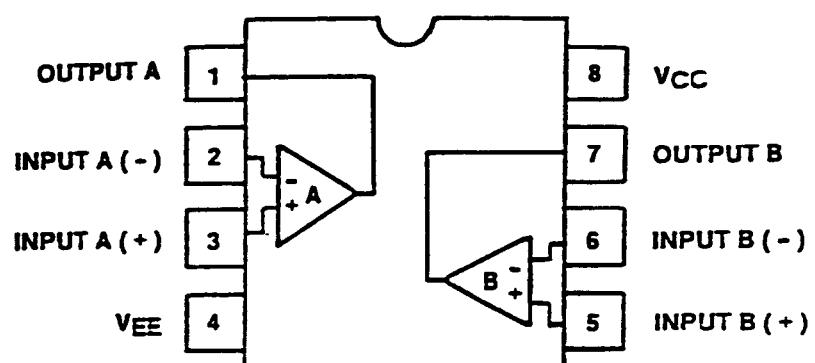


GE-NET TMX
Audio Board

L.C.	TYPE	+BV	GND
U301	MC4558	5	4
U302	MC4558	5	4
U303	MC4558	5	4
U601	LM324	3	12
U602	MC4558	5	4
U603	MC4558	5	4
U604	LM324	5	11
U605	LM324	4	11

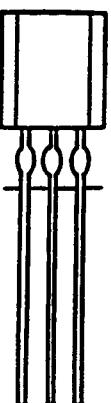
(19D902194, Sh. 2, Rev. 1)

OPERATIONAL AMPLIFIER
(U602 & U603)
19A700086P4



RC-8041

VOLTAGE REGULATORS
(U606)
19A704073P2

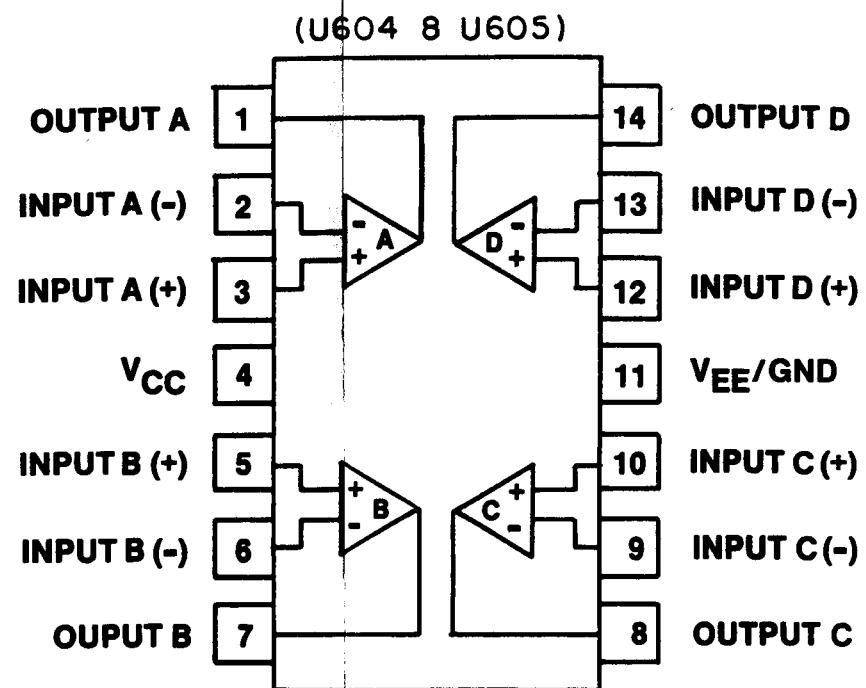


BOTTOM VIEW

PIN 1 - OUTPUT
PIN 2 - GROUND
PIN 3 - INPUT

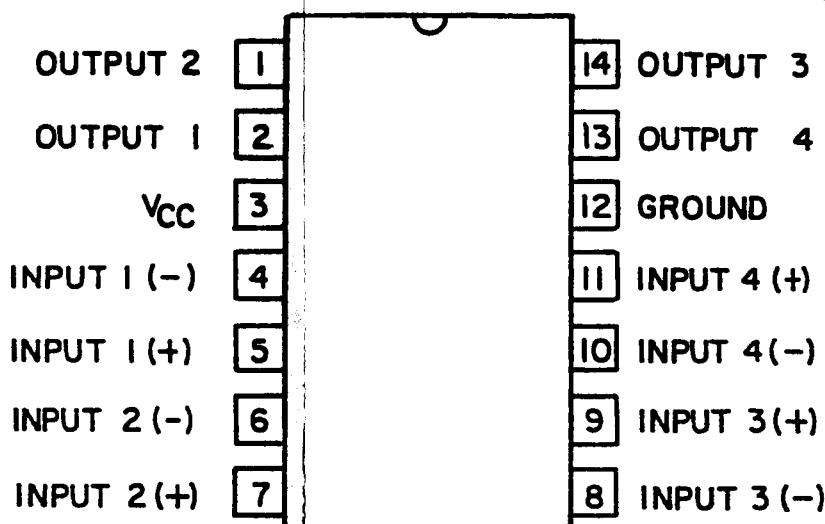
RC-5289

OPERATIONAL AMPLIFIER
19A701789P1



RC-5887

OPERATIONAL AMPLIFIER
19A134764P1
(U601)
PIN CONNECTIONS



RC-8042

TOP VIEW

GE-NET TMX
Audio Board